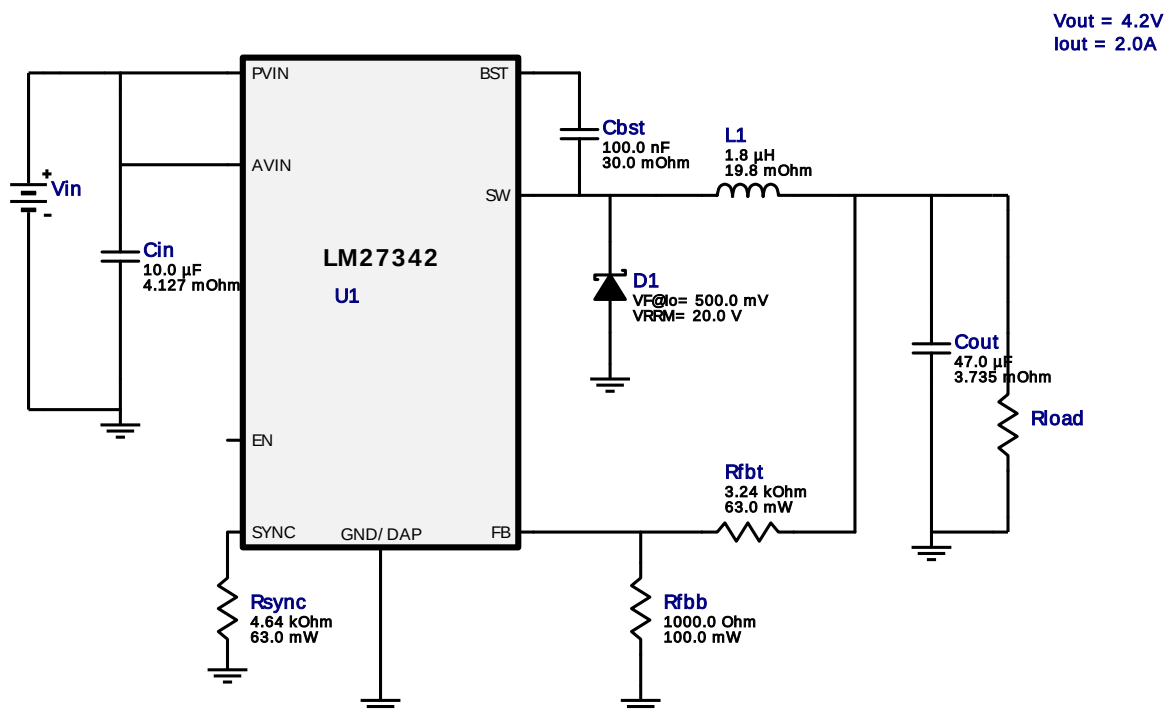


WEBENCH® Design Report

Design : 4743359/47 LM27342MY/NOPB
LM27342MY/NOPB 6.0V-8.4V to 4.20V @ 2.0A

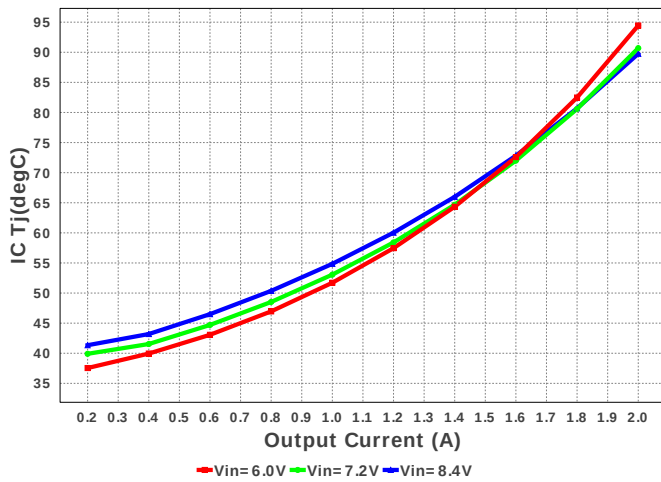


Electrical BOM

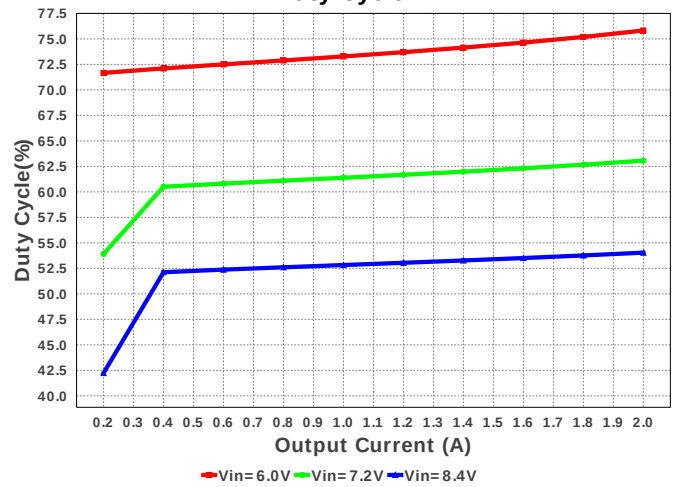
#	Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
1.	Cbst	MuRata	GRM188R71C104KA01D Series= X7R	Cap= 100.0 nF ESR= 30.0 mOhm VDC= 16.0 V IRMS= 1.7 A	1	\$0.01	0603 5 mm ²
2.	Cin	MuRata	GRM21BR61C106KE15L Series= X5R	Cap= 10.0 uF ESR= 4.127 mOhm VDC= 16.0 V IRMS= 2.46634 A	1	\$0.03	0805 7 mm ²
3.	Cout	MuRata	GRM31CC80J476KE18L Series= X6S	Cap= 47.0 uF ESR= 3.735 mOhm VDC= 6.3 V IRMS= 4.0522 A	1	\$0.10	1206_190 11 mm ²
4.	D1	Diodes Inc.	B220-13-F	VF@Io= 500.0 mV VRRM= 20.0 V	1	\$0.08	SMB 44 mm ²
5.	L1	Bourns	SRN6045-1R8Y	L= 1.8 µH DCR= 19.8 mOhm	1	\$0.16	SRN6045 64 mm ²
6.	Rfbb	Vishay-Dale	CRCW06031K00FKEA Series= CRCW..e3	Res= 1000.0 Ohm Power= 100.0 mW Tolerance= 1.0%	1	\$0.01	0603 5 mm ²
7.	Rfbb	Vishay-Dale	CRCW04023K24FKED Series= CRCW..e3	Res= 3.24 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm ²

#	Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
8.	Rsync	Vishay-Dale	CRCW04024K64FKED Series= CRCW..e3	Res= 4.64 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm²
9.	U1	Texas Instruments	LM27342MY/NOPB	Switcher	1	\$1.20	 MUC10A 24 mm²

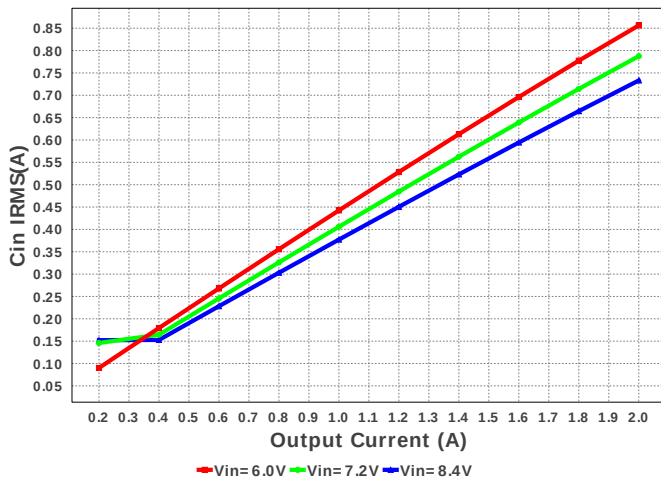
IC Tj



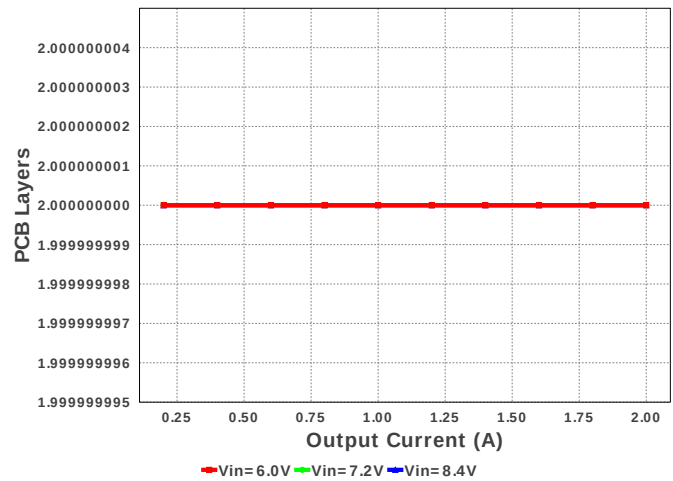
Duty Cycle

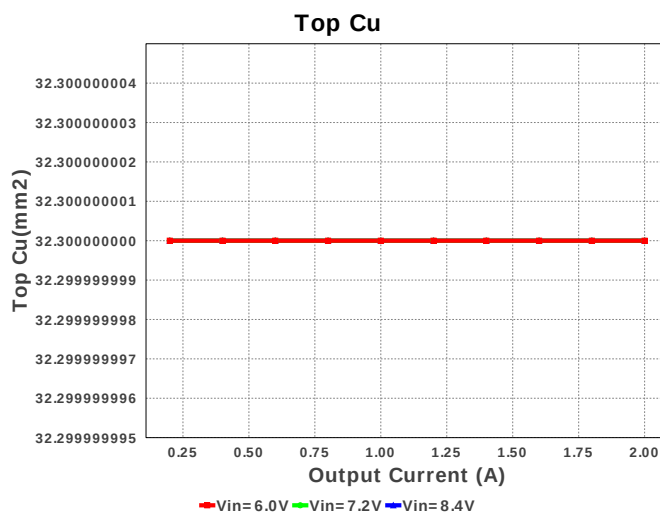
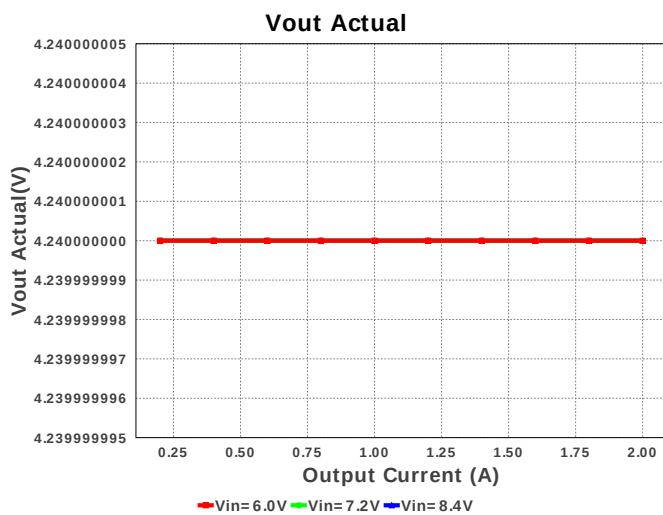
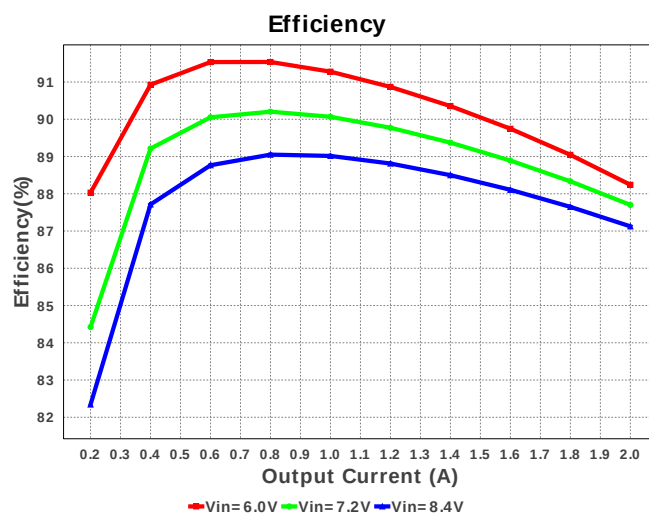
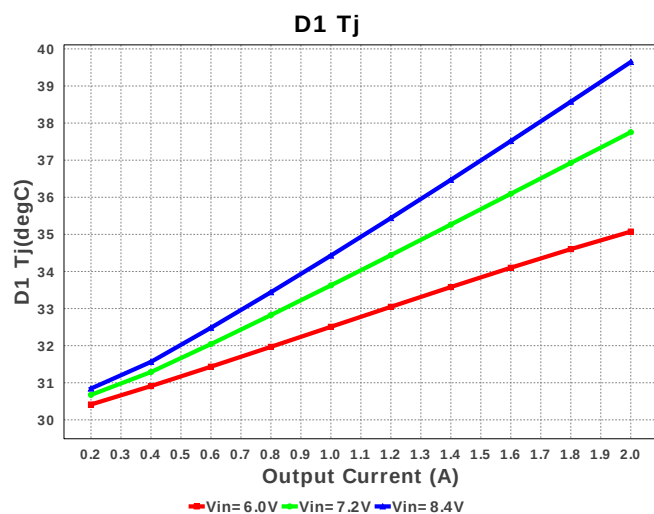
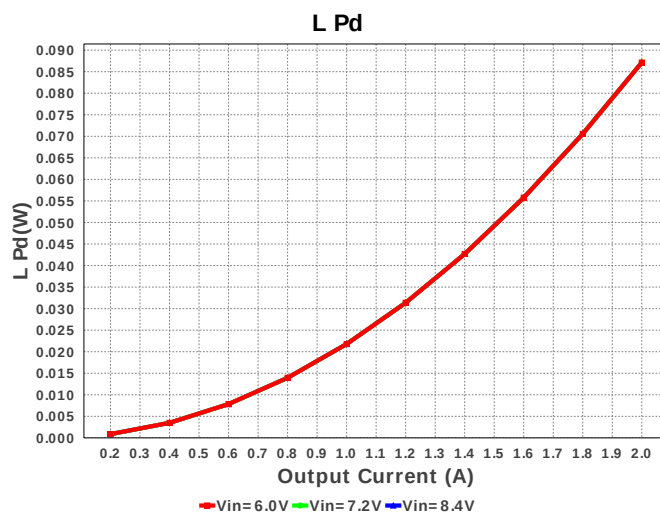
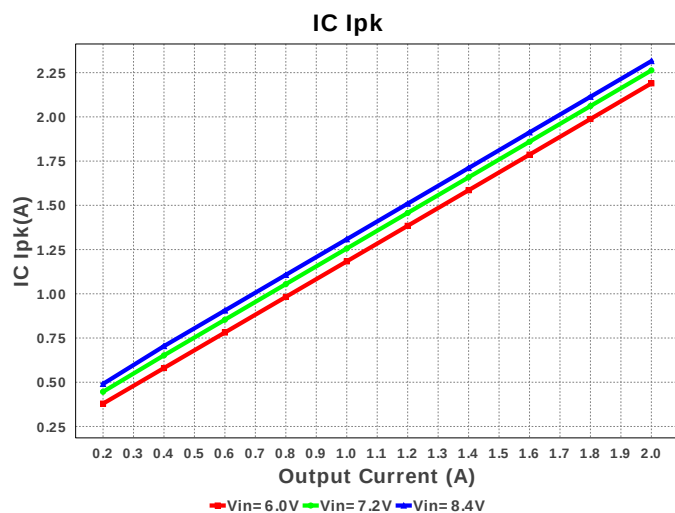


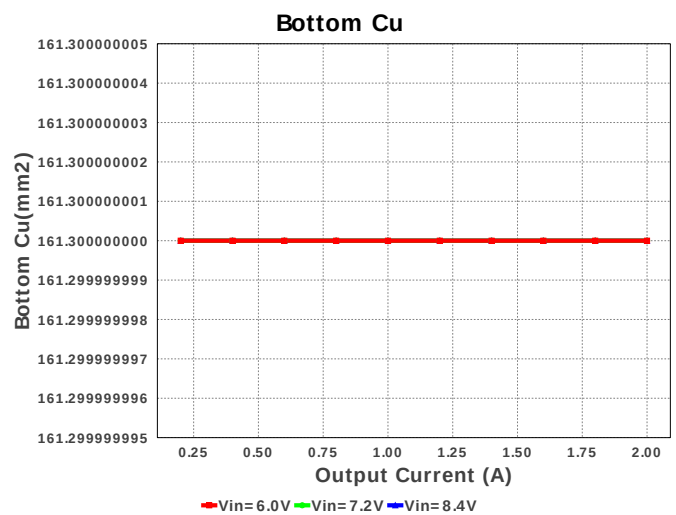
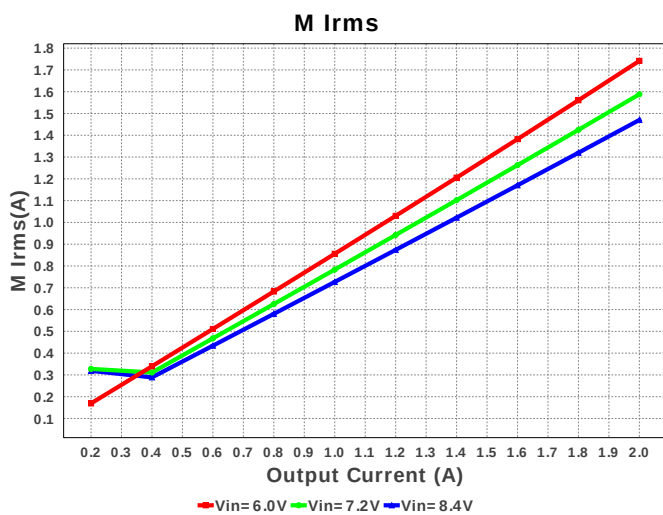
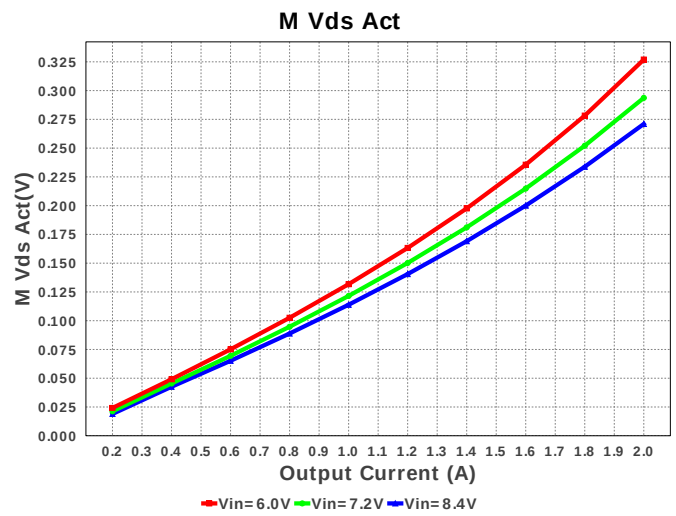
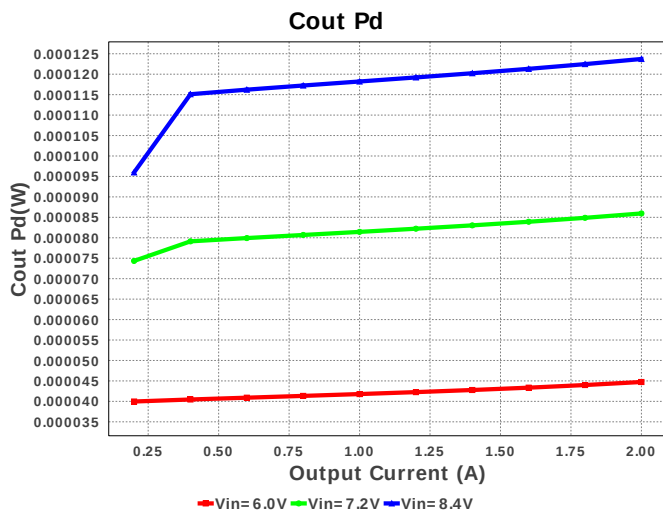
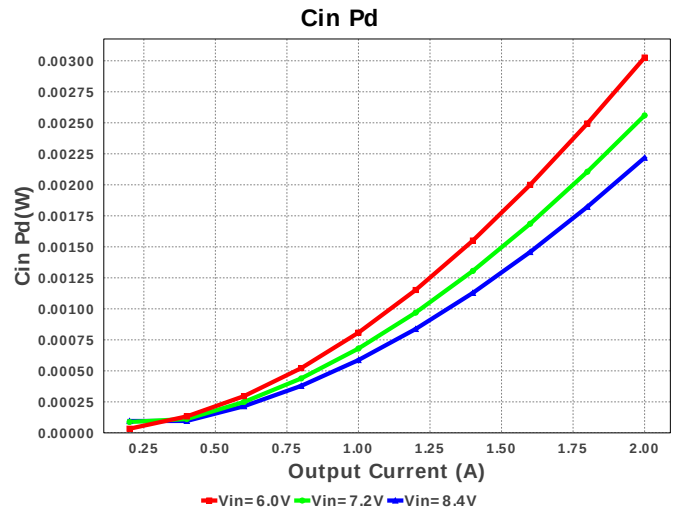
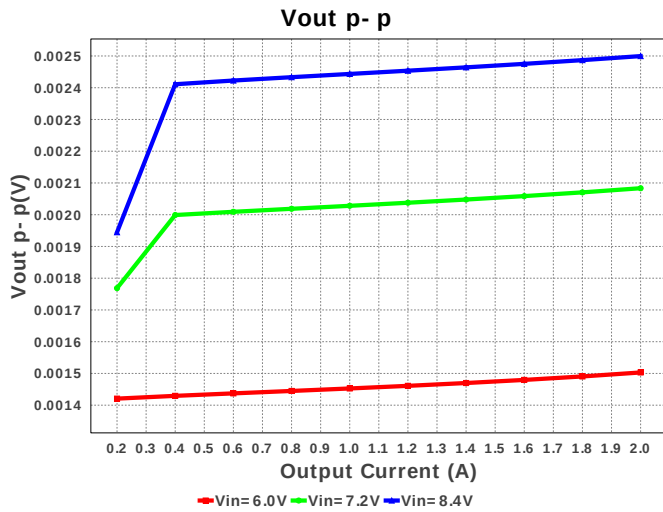
Cin IRMS

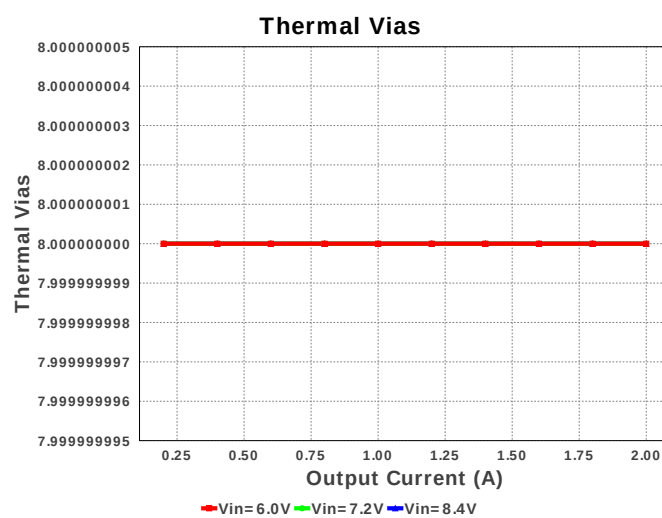
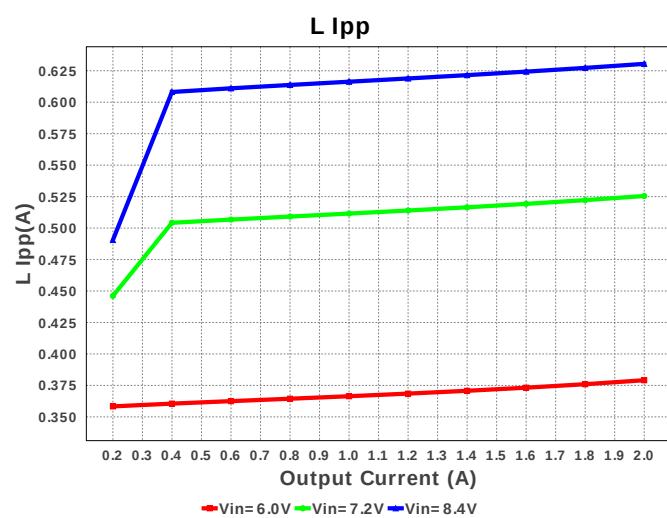
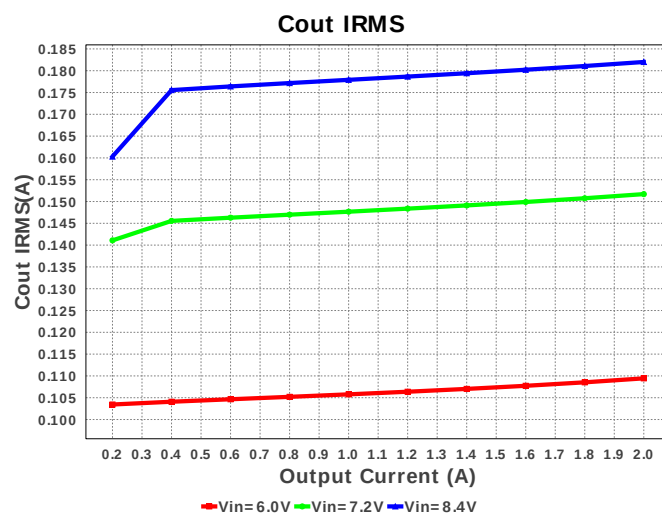
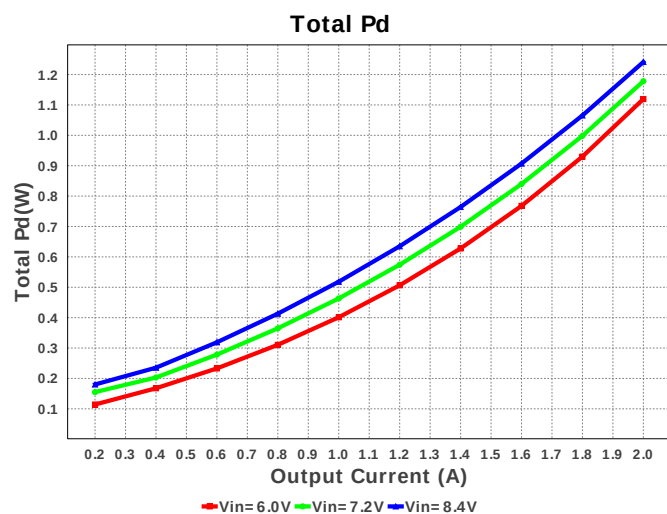
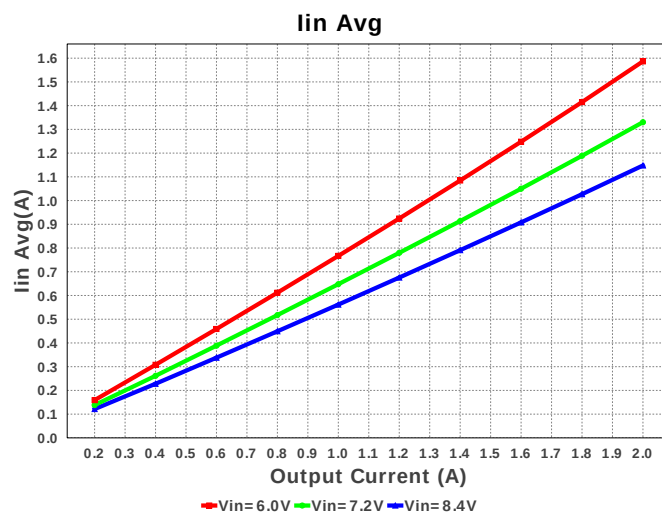
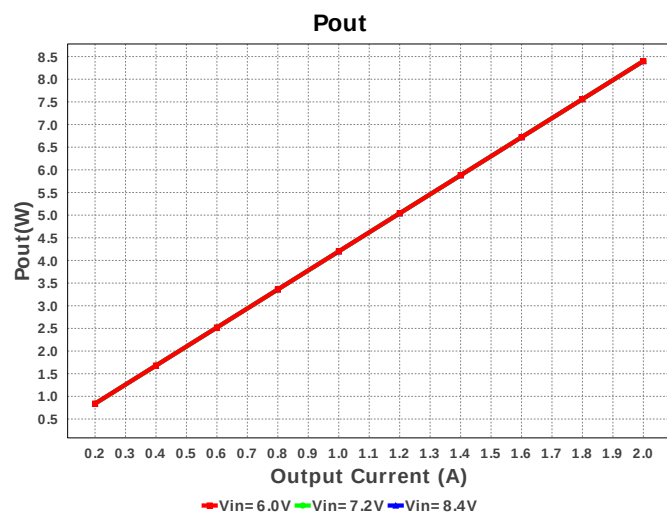


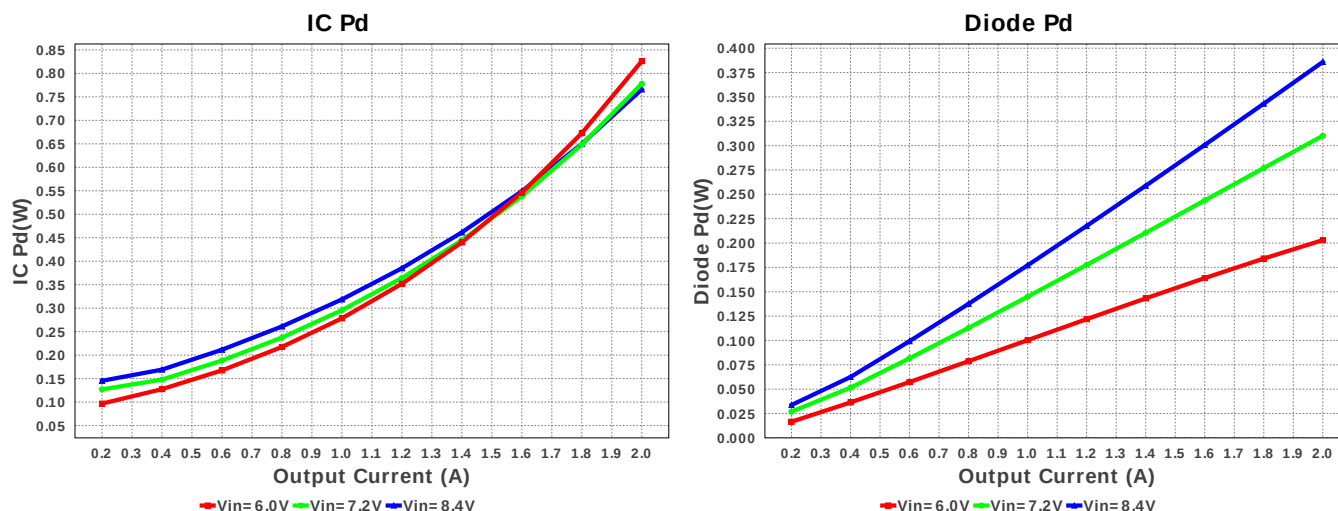
PCB Layers











Operating Values

#	Name	Value	Category	Description
1.	Bottom Cu	161.3 mm ²	Board_Layout	Recommended minimum area of bottom layer copper connected to DAP
2.	PCB Layers	2.0	Board_Layout	Recommended number of PCB layers for the necessary IC Thermal Resistance
3.	Thermal Vias	8.0	Board_Layout	Recommended number of 10 mil thermal vias under the IC
4.	Top Cu	32.3 mm ²	Board_Layout	Recommended minimum area of top layer copper connected to DAP
5.	Cin IRMS	738.314 mA	Current	Input capacitor RMS ripple current
6.	Cout IRMS	180.796 mA	Current	Output capacitor RMS ripple current
7.	IC Ipk	2.313 A	Current	Peak switch current in IC
8.	Iin Avg	1.139 A	Current	Average input current
9.	L Ipp	626.29 mA	Current	Peak-to-peak inductor ripple current
10.	M1 Irms	1.465 A	Current	Q lavg
11.	BOM Count	9	General	Total Design BOM count
12.	FootPrint	165.0 mm ²	General	Total Foot Print Area of BOM components
13.	Frequency	2.0 MHz	General	Switching frequency
14.	IC Tolerance	10.0 mV	General	IC Feedback Tolerance
15.	M Vds Act	237.48 mV	General	Voltage drop across the MosFET
16.	Pout	8.4 W	General	Total output power
17.	Total BOM	\$1.61	General	Total BOM Cost
18.	D1 Tj	39.092 degC	Op_Point	D1 junction temperature
19.	Vout Actual	4.24 V	Op_Point	Vout Actual calculated based on selected voltage divider resistors
20.	Vout OP	4.2 V	Op_Point	Operational Output Voltage
21.	Duty Cycle	53.682 %	Op_point	Duty cycle
22.	Efficiency	87.786 %	Op_point	Steady state efficiency
23.	IC Tj	62.201 degC	Op_point	IC junction temperature
24.	ICThetaJA	45.0 degC/W	Op_point	IC junction-to-ambient thermal resistance
25.	IOUT_OP	2.0 A	Op_point	Iout operating point
26.	VIN_OP	8.4 V	Op_point	Vin operating point
27.	Vout Act	4.24 V	Op_point	Achieved Vout with feedback resistor pair
28.	Vout p-p	2.483 mV	Op_point	Peak-to-peak output ripple voltage
29.	Cin Pd	2.25 mW	Power	Input capacitor power dissipation
30.	Cout Pd	122.086 μW	Power	Output capacitor power dissipation
31.	Diode Pd	363.675 mW	Power	Diode power dissipation
32.	IC Pd	715.579 mW	Power	IC power dissipation
33.	L Pd	87.12 mW	Power	Inductor power dissipation
34.	Total Pd	1.169 W	Power	Total Power Dissipation
35.	Vout Tolerance	2.559 %		Vout Tolerance based on IC Tolerance (no load) and voltage divider resistors if applicable

Design Inputs

#	Name	Value	Description
1.	Iout	2.0	Maximum Output Current
2.	VinMax	8.4	Maximum input voltage
3.	VinMin	6.0	Minimum input voltage
4.	Vout	4.2	Output Voltage
5.	base_pn	LM27342	Base Product Number
6.	source	DC	Input Source Type
7.	Ta	30.0	Ambient temperature

Design Assistance

1. **LM27342** Product Folder : <http://www.ti.com/product/LM27342> : contains the data sheet and other resources.

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